

Block Diagram

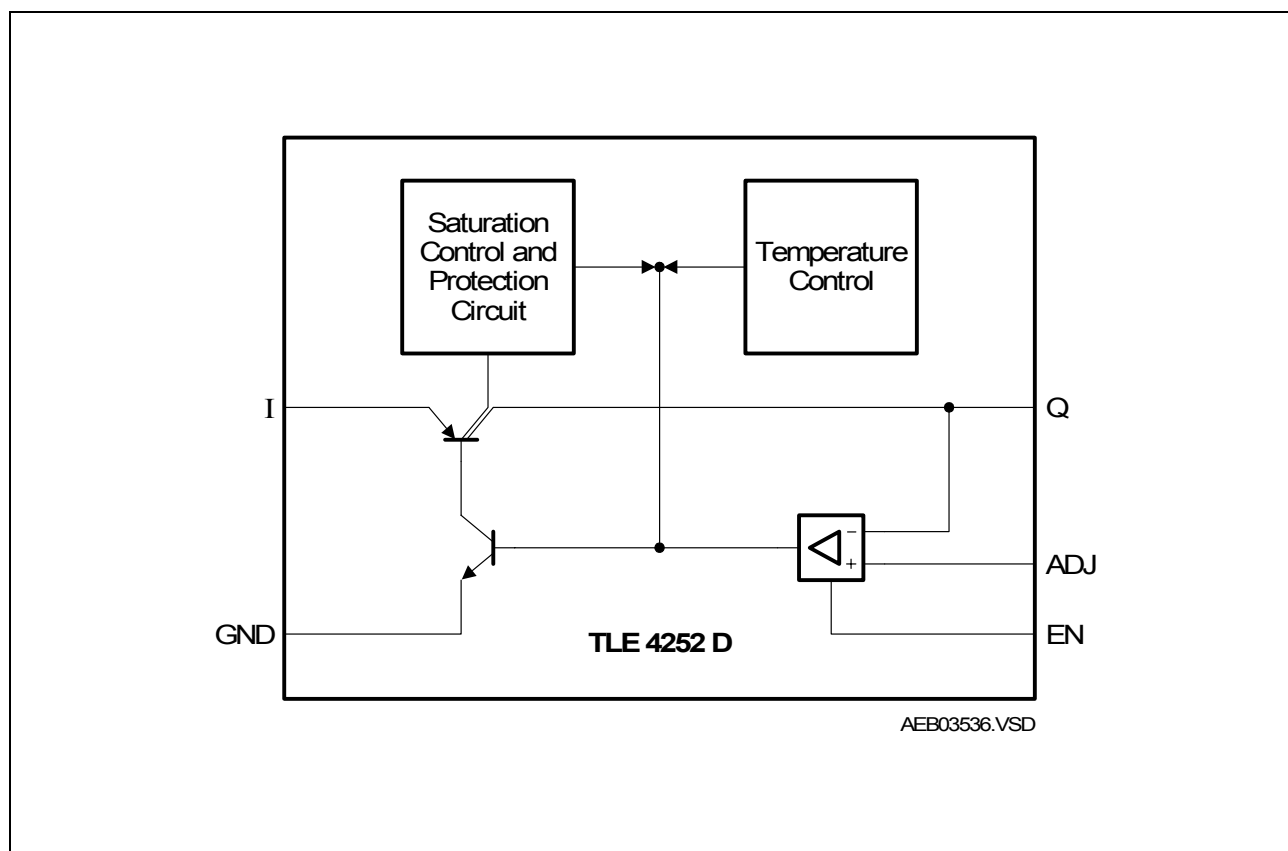


Figure 1 Internal Circuit Blocks

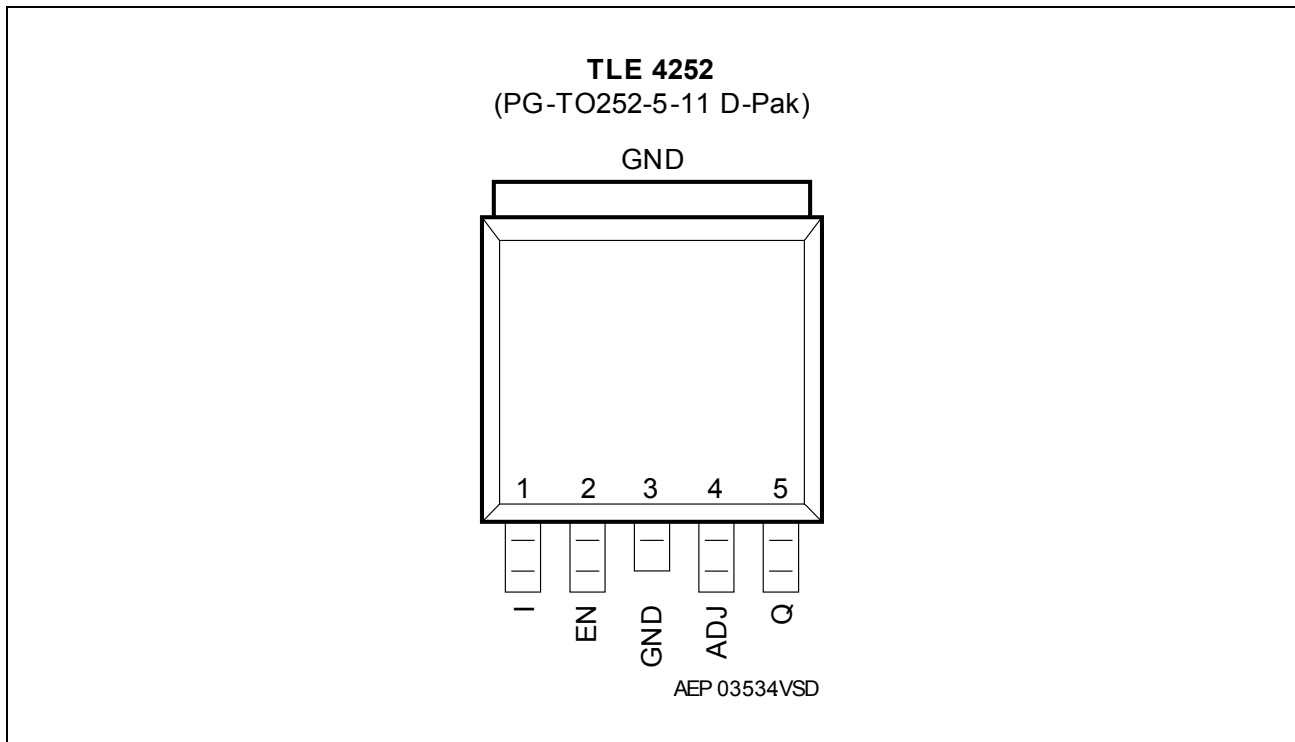


Figure 2 Pin Configuration (Draft, subject to alternation!)

Table 1 Pin Definitions and Functions (draft, subject to alternation)

Pin No.	Symbol	Function
1	I	Supply voltage input; Input for battery or a pre-regulated voltage of a e.g. DC to DC converter.
2	EN	Enable input for tracker; An active high signal turns on the device, with active low the tracker is turned off.
3	GND	Ground; Connected to the heatsink of the package.
4	ADJ	Adjust input for tracker; Input for the reference voltage which can be connected directly or by voltage divider to the reference (see Application Information).
5	Q	Output voltage of tracker; For a stable operation to avoid ringing at the output connect a capacitor of $C_Q \geq 10 \mu\text{F}$ and $0 \leq \text{ESR} \leq 5 \Omega$ to GND.

Table 2 Absolute Maximum Ratings

Parameter	Symbol	Limit Values		Unit	Remarks
		Min.	Max.		
Supply Voltage Input I					
Voltage	V_I	-42	45	V	–
Current	I_I	–	–	A	Limited internally
Enable Input EN					
Voltage	V_{EN}	-42	45	V	–
Current	I_{EN}	–	–	A	Limited internally
Adjust Input ADJ					
Voltage	V_{ADJ}	-42	45	V	–
Current	I_{ADJ}	–	–	A	Limited internally
Output Q					
Voltage	V_Q	-2	45	V	–
Current	I_Q	–	–	A	Limited internally
Temperature					
Junction temperature	T_j	-40	150	°C	–
Storage temperature	T_{stg}	-50	150	°C	–
ESD-Protection					
Voltage	V_{ESD}	-2	2	kV	Human Body Model (HBM)

Note: Maximum ratings are absolute ratings, exceeding one of these values may cause irreversible damage to the integrated circuit!

Table 3 Operating Range

Parameter	Symbol	Limit Values			Unit	Remarks
		Min.	Typ.	Max.		
In- and Output Voltage						
Supply voltage	V_I	3.5	–	40	V	$V_I > V_{ADJ} + V_{dr}$
Enable input voltage	V_{EN}	0	–	40	V	–
Adjust input voltage	V_{ADJ}	1.5	–	40	V	–
Adjust input voltage	V_{ADJ}	0	–	1.5	V	$V_Q \leq V_{ADJ} + \Delta V_Q$
Error amplifier common mode range	CMR	1.5	–	$V_I - 0.5$	V	$V_Q \leq V_{ADJ} + \Delta V_Q$ with $V_{FB} = V_Q$
Temperature						
Junction temperature	T_j	-40	–	150	°C	–
Thermal Resistance PG-TO252-5-11						
Junction to ambient	R_{thj-a}	–	–	144	K/W	Footprint only ¹⁾
Junction to ambient	R_{thj-a}	–	–	78	K/W	Heat sink area 300 mm ² ¹⁾
Junction to ambient	R_{thj-a}	–	–	55	K/W	Heat sink area 600 mm ² ¹⁾
Junction to case	R_{thj-c}	–	–	2	K/W	–

1) Worst case regarding peak temperature; zero airflow; mounted on FR4; 80 × 80 × 1.5 mm³; 35 μ Cu; 5 μ Sn

Note: Within this operating range the IC is functional. The electrical characteristics, however, are not guaranteed over this full range given above.

Table 4 Electrical Characteristics
 $V_I = 13.5 \text{ V}; 1.5 \text{ V} \leq V_{\text{ADJ}} \leq V_I - 0.6 \text{ V}; -40 \text{ }^\circ\text{C} < T_j < 150 \text{ }^\circ\text{C};$ unless otherwise specified

Parameter	Symbol	Limit Values			Unit	Test Condition
		Min.	Typ.	Max.		
Regulator Performance, Tracker Output Q						
Output voltage tracking accuracy $\Delta V_Q = V_{\text{ADJ}} - V_Q$	ΔV_Q	-10	–	10	mV	$4.5 \text{ V} < V_I < 26 \text{ V};$ $1 \text{ mA} < I_Q < 200 \text{ mA};$
Output voltage tracking accuracy $\Delta V_Q = V_{\text{ADJ}} - V_Q$	ΔV_Q	-10	–	10	mV	$3.5 \text{ V} < V_I < 32 \text{ V};$ $10 \text{ mA} < I_Q < 100 \text{ mA};$
		-25	–	25	mV	$3.5 \text{ V} < V_I < 4.5 \text{ V};$ $1 \text{ mA} < I_Q < 200 \text{ mA};$
Drop voltage	V_{dr}	–	280	600	mV	$I_Q = 200 \text{ mA};$ $V_{\text{ADJ}} > 3.5 \text{ V};$ $V_{\text{EN}} = V_{\text{EN, on}}^{1)}$
Output current	I_Q	250	350	500	mA	$V_Q = 5.0 \text{ V}^{2)}$
Output capacitor	C_Q	10	–	–	μF	$0 \leq \text{ESR} \leq 5 \Omega$ at 10 kHz
Current consumption $I_q = I_I - I_Q$	I_q	–	10	25	mA	$I_Q = 200 \text{ mA};$ $V_Q = 5 \text{ V}$
Current consumption $I_q = I_I - I_Q$	I_q	–	100	150	μA	$I_Q < 100 \mu\text{A};$ $T_j < 85 \text{ }^\circ\text{C}; V_{\text{EN}} = 5 \text{ V}$
Quiescent current (stand-by) $I_q = I_I - I_Q$	I_q	–	0	2	μA	$V_{\text{EN}} = 0 \text{ V};$ $V_{\text{EN/ADJ}} = 0 \text{ V};$ $T_j < 85 \text{ }^\circ\text{C}$
Reverse current	I_r	–	0.5	5	mA	$V_Q = 16 \text{ V}; V_I = 0 \text{ V}$
Load regulation	ΔV_Q	–	–	10	mV	$1 \text{ mA} < I_Q < 200 \text{ mA}$
Line regulation	ΔV_Q	–	–	10	mV	$5 \text{ V} < V_I < 32 \text{ V};$ $I_Q = 5 \text{ mA}$
Power supply ripple rejection	$PSSR$	–	60	–	dB	$f_{\text{I, ripple}} = 100 \text{ Hz};$ $V_{\text{I, ripple}} = 0.5 \text{ Vpp}^{3)}$

Table 4 Electrical Characteristics (cont'd)
 $V_I = 13.5 \text{ V}; 1.5 \text{ V} \leq V_{\text{ADJ}} \leq V_I - 0.6 \text{ V}; -40 \text{ }^\circ\text{C} < T_j < 150 \text{ }^\circ\text{C};$ unless otherwise specified

Parameter	Symbol	Limit Values			Unit	Test Condition
		Min.	Typ.	Max.		
Adjust Input ADJ						
Input biasing current	I_{ADJ}	—	0.1	0.5	μA	$V_{\text{ADJ}} = 5 \text{ V}$
Enable Input EN						
Device on voltage range	$V_{\text{EN, on}}$	2.0	—	40	V	V_{Q} settled
Device off voltage range	$V_{\text{EN, off}}$	0	—	0.8	V	$V_{\text{Q}} < 0.1 \text{ V}$
Input current	I_{EN}	-1	2	5	μA	$V_{\text{EN}} = 5 \text{ V}$
EN pull-down resistor	R_{EN}	—	1.5	—	MΩ	—

1) Measured when the output voltage V_Q has dropped 100 mV from the nominal value.

2) The current limit depends also on the input voltage, see graph output current vs. input voltage in the diagrams section.

3) Specified by design. Not subject to production test.

Application Information

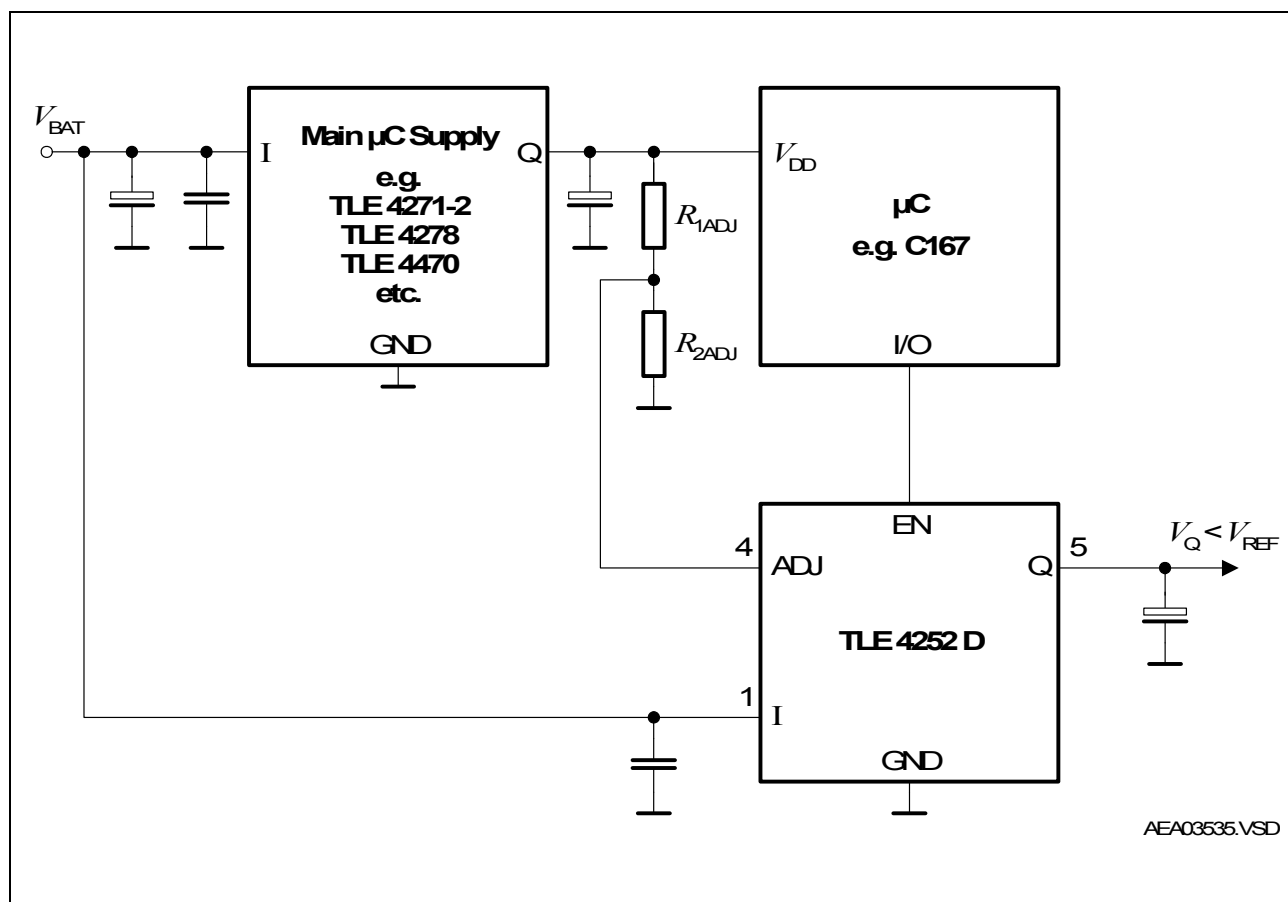


Figure 3 Application Circuit: Output Voltage < Reference Voltage

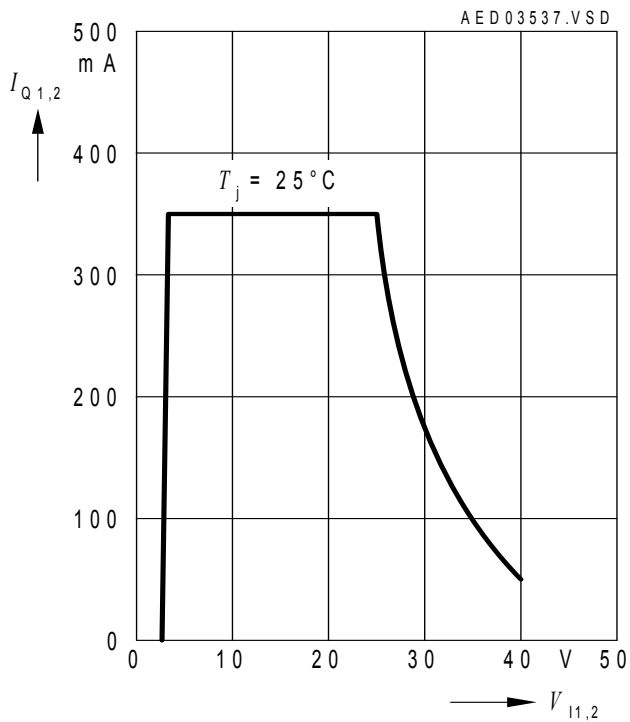
Figure 3 shows a typical application circuit with $V_Q < V_{REF}$. Of course, also $V_Q = V_{REF}$ is feasible by directly connecting the reference pin of the TLE 4252 D to the appropriate voltage level without voltage divider.

The output voltage calculates to:

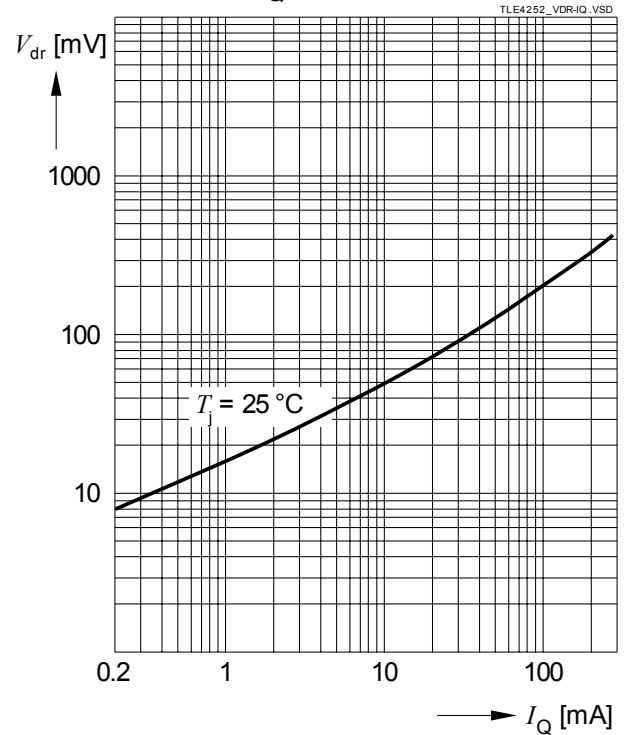
$$V_Q = V_{REF} \times \left(\frac{R_{2ADJ}}{R_{1ADJ} + R_{2ADJ}} \right) \quad (1)$$

Diagrams

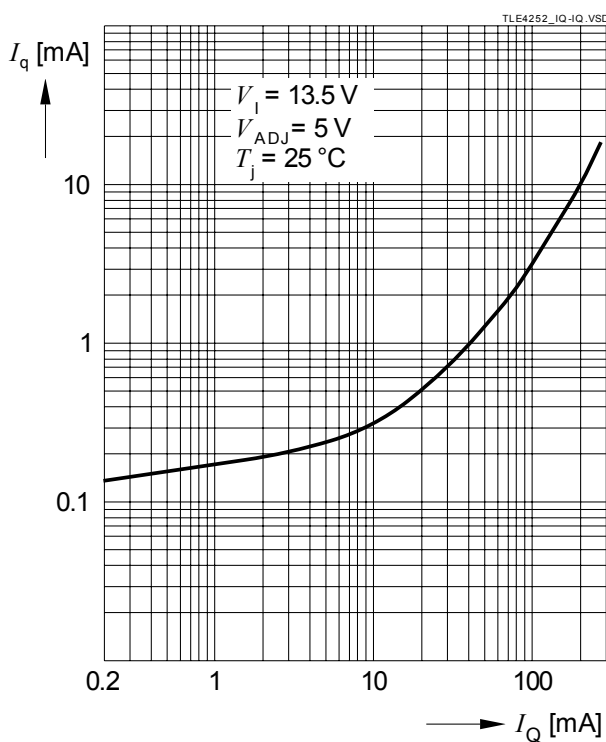
Output Current Limit I_Q versus Input Voltage V_I



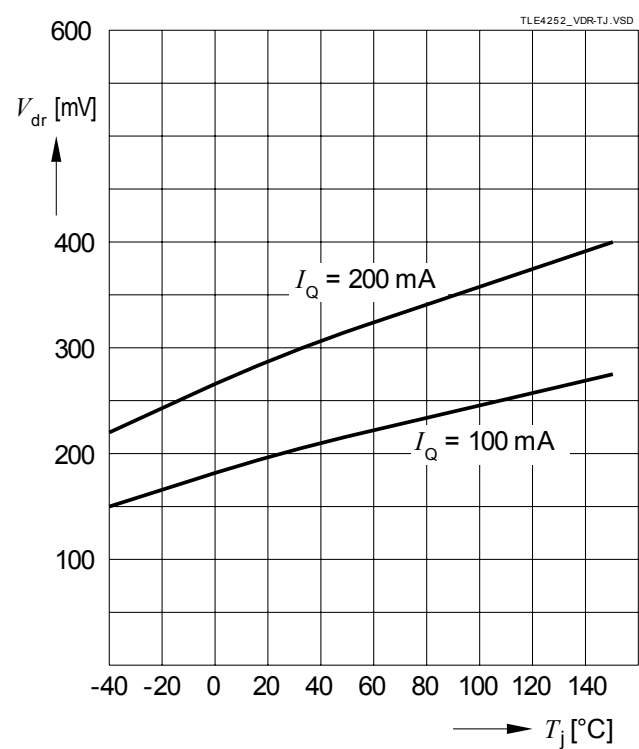
Drop Voltage V_{DR} versus Output Current I_Q



Current Consumption I_Q versus Output Current I_Q



Drop Voltage V_{DR} versus Junction Temperature T_j



Package Outlines

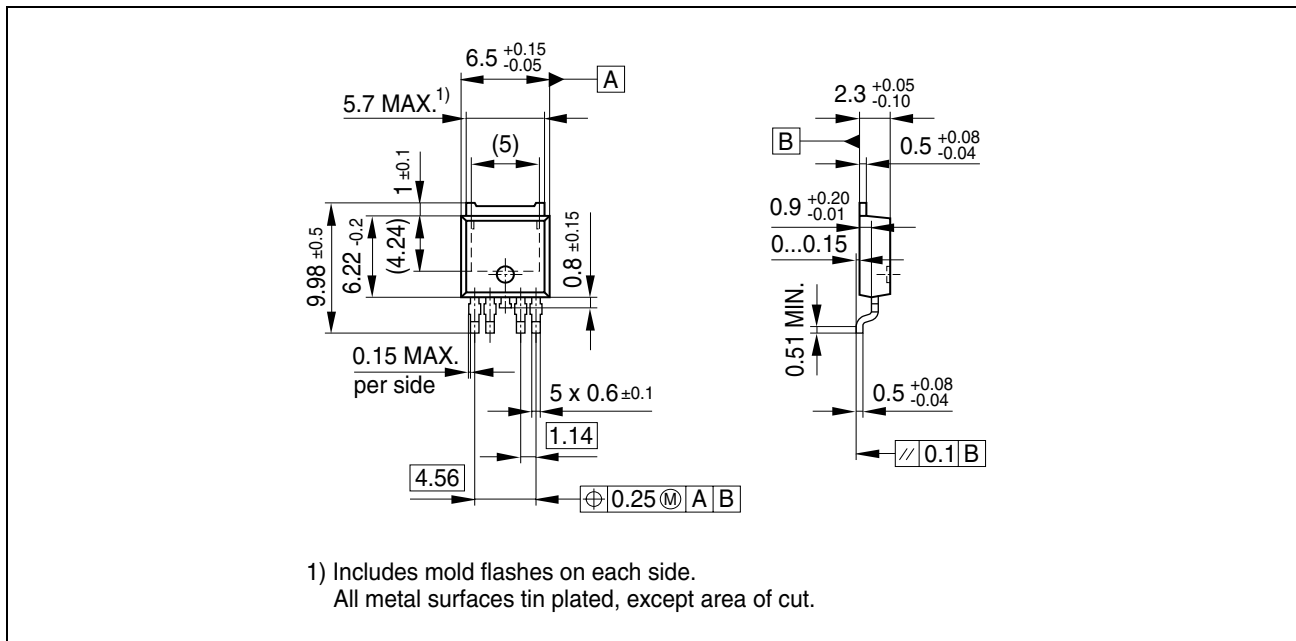


Figure 4 PG-T0252-5-11 (Plastic Transistor Single Outline)

Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

You can find all of our packages, sorts of packing and others in our Infineon Internet Page "Products": <http://www.infineon.com/products>.

SMD = Surface Mounted Device

Dimensions in mm

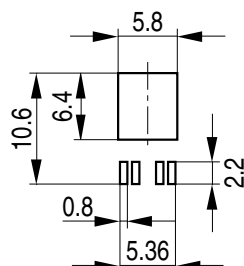


Figure 5 Foot Print for PG-TO-252-5-11 (Plastic Transistor Single Outline)

Revision History**Revision History**

Version	Date	Changes
Rev. 1.4	2007-03-20	Initial version of RoHS-compliant derivate of TLE 4252 Page 1 : AEC certified statement added Page 1 and Page 10 : RoHS compliance statement and Green product feature added Page 1 and Page 10 : Package changed to RoHS compliant version Legal Disclaimer updated

Edition 2007-03-20

**Published by
Infineon Technologies AG
81726 Munich, Germany**

**© 2007 Infineon Technologies AG
All Rights Reserved.**

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (www.infineon.com).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.